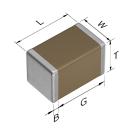
积层贴片陶瓷片式电容器

C2012JB1C685K125AC

RoHS Reach Halogen Free Pb Free

交货型号	C2012JB1C685KT****	
用途	一般等级	
特点	General 一般(~75V)	
系列	C2012 [EIA 0805]	
状态	量产体制(新设计非推荐)	



尺寸		
长度(L)	$2.00 \text{mm} \pm 0.20 \text{mm}$	
宽度(W)	1.25mm ±0.20mm	
厚度(T)	1.25mm ±0.20mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.50mm Min.	
推荐焊盘布局(PA)	1.00mm to 1.30mm(Flow Soldering)	
1世代产血4月1月(11八)	0.90mm to 1.20mm(Reflow Soldering)	
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)	
进行/产益/11/月 (LD)	0.70mm to 0.90mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)	
3世行が平価41月10(はし)	0.90mm to 1.20mm(Reflow Soldering)	

电气特性		
电容	6.8 μ F ±10%	
额定电压	16VDC	
温度特性	JB(±10%)	
耗散因数(Max.)	10%	
绝缘电阻 (Min.)	14ΜΩ	

	其他
焊接方法	流体
件按刀伍	回流
AEC-Q200	NO NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

[!] Images are for reference only and show exemplary products.

[!] This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

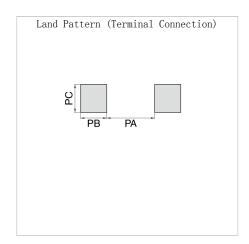
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Associated Images



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